

# 74LV393

## Dual 4-bit binary ripple counter

Rev. 3 — 28 April 2014

Product data sheet

### 1. General description

The 74LV393 is a low-voltage Si-gate CMOS device and is pin and function compatible with 74HC393 and 74HCT393.

The 74LV393 is a dual 4-stage binary ripple counter. Each counter features a clock input ( $\overline{nCP}$ ), an overriding asynchronous master reset input ( $\overline{nMR}$ ) and 4 buffered parallel outputs ( $nQ0$  to  $nQ3$ ). The counter advances on the HIGH-to-LOW transition of  $\overline{nCP}$ . A HIGH on  $\overline{nMR}$  clears the counter stages and forces the outputs LOW, independent of the state of  $\overline{nCP}$ .

### 2. Features and benefits

- Optimized for low voltage applications: 1.0 V to 3.6 V
- Accepts TTL input levels between  $V_{CC} = 2.7$  V and  $V_{CC} = 3.6$  V
- Typical  $V_{OLP}$  (output ground bounce) 0.8 V at  $V_{CC} = 3.3$  V,  $T_{amb} = 25$  °C
- Typical  $V_{OHV}$  (output  $V_{OH}$  undershoot) 2 V at  $V_{CC} = 3.3$  V,  $T_{amb} = 25$  °C
- Two 4-bit binary counters with individual clocks
- Divide-by any binary module up to 28 in one package
- Two master resets to clear each 4-bit counter individually
- Complies with JEDEC standard no. 7A
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ◆ MM JESD22-A115-A exceeds 200 V

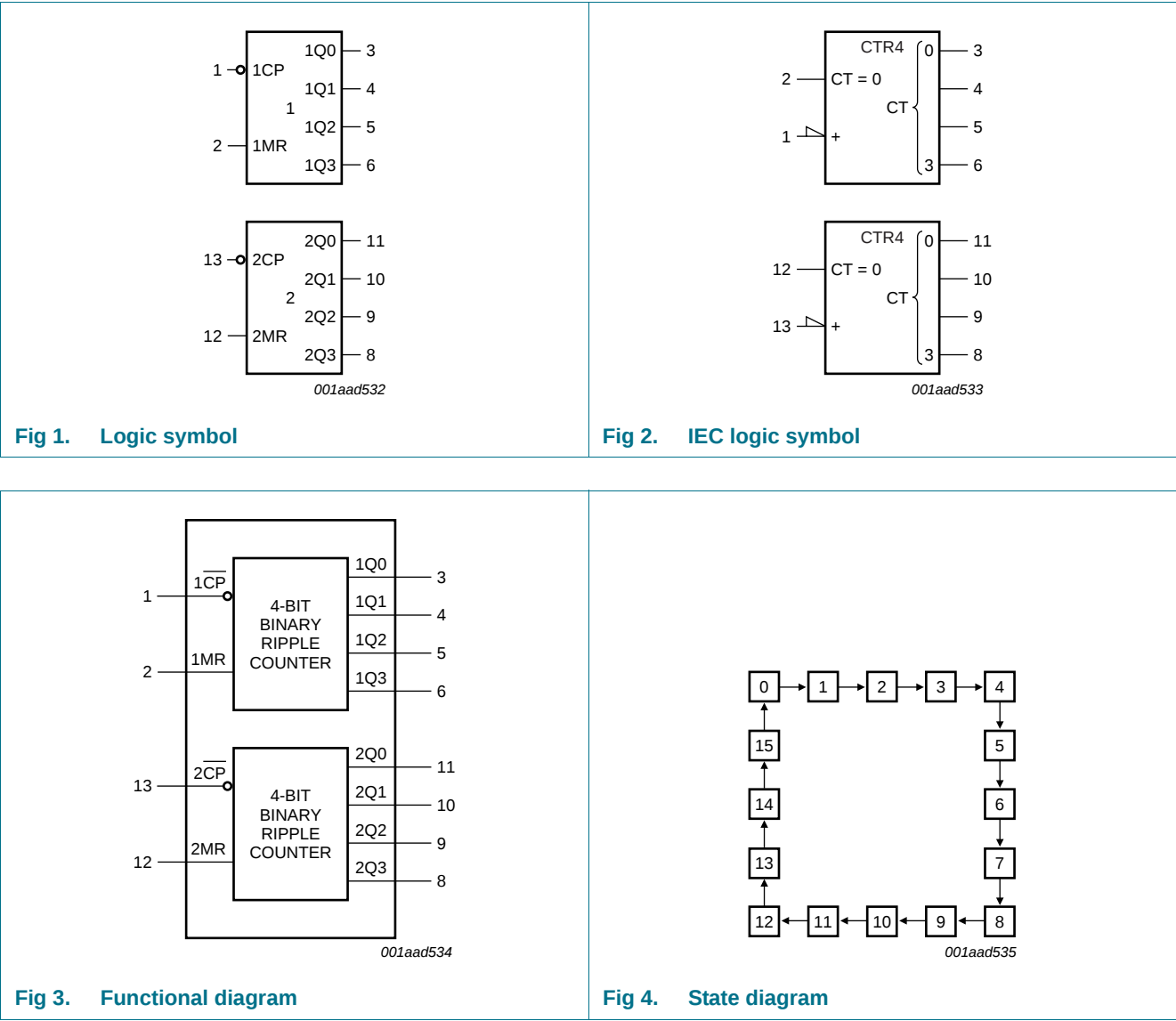
### 3. Ordering information

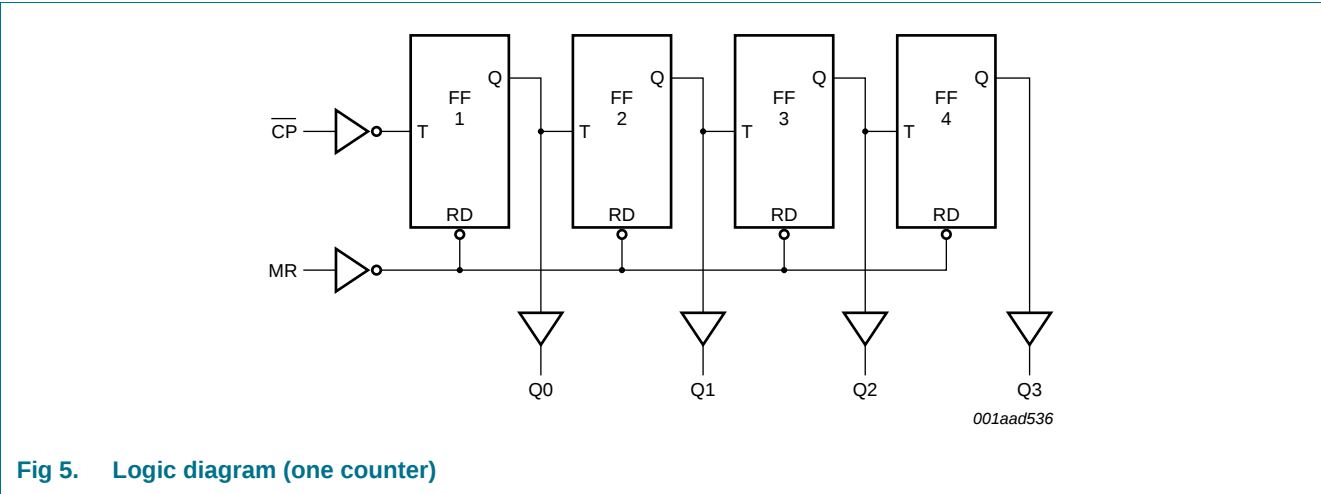
Table 1. Ordering information

| Type number | Package           |         |                                                                        |          |
|-------------|-------------------|---------|------------------------------------------------------------------------|----------|
|             | Temperature range | Name    | Description                                                            | Version  |
| 74LV393N    | –40 °C to +125 °C | DIP14   | plastic dual in-line package; 14 leads (300 mil)                       | SOT27-1  |
| 74LV393D    | –40 °C to +125 °C | SO14    | plastic small outline package; 14 leads; body width 3.9 mm             | SOT108-1 |
| 74LV393DB   | –40 °C to +125 °C | SSOP14  | plastic shrink small outline package; 14 leads; body width 5.3 mm      | SOT337-1 |
| 74LV393PW   | –40 °C to +125 °C | TSSOP14 | plastic thin shrink small outline package; 14 leads; body width 4.4 mm | SOT402-1 |



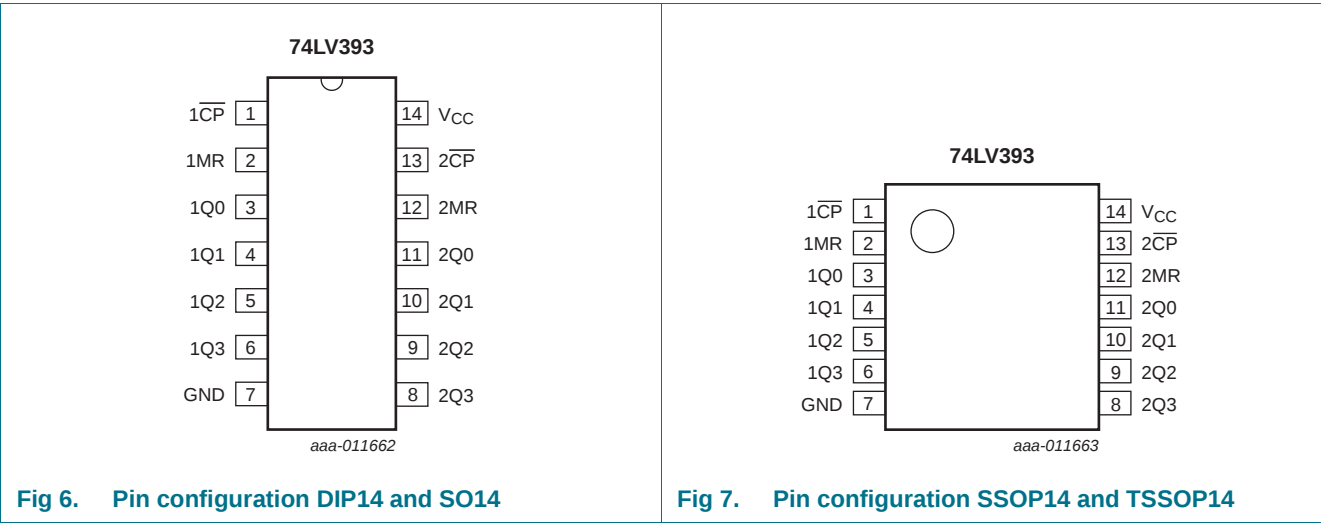
4. Functional diagram





## 5. Pinning information

### 5.1 Pinning



### 5.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description                                   |
|--------|-----|-----------------------------------------------|
| 1CP    | 1   | clock input (HIGH-to-LOW, edge-triggered)     |
| 1MR    | 2   | asynchronous master reset input (active HIGH) |
| 1Q0    | 3   | flip-flop output                              |
| 1Q1    | 4   | flip-flop output                              |
| 1Q2    | 5   | flip-flop output                              |
| 1Q3    | 6   | flip-flop output                              |
| GND    | 7   | ground (0 V)                                  |
| 2Q3    | 8   | flip-flop output                              |

Table 2. Pin description ...continued

| Symbol          | Pin | Description                                   |
|-----------------|-----|-----------------------------------------------|
| 2Q2             | 9   | flip-flop output                              |
| 2Q1             | 10  | flip-flop output                              |
| 2Q0             | 11  | flip-flop output                              |
| 2MR             | 12  | asynchronous master reset input (active HIGH) |
| 2CP             | 13  | clock input (HIGH-to-LOW, edge-triggered)     |
| V <sub>CC</sub> | 14  | supply voltage                                |

## 6. Functional description

Table 3. Count sequence for one counter [1]

| Count | Output |     |     |     |
|-------|--------|-----|-----|-----|
|       | nQ0    | nQ1 | nQ2 | nQ3 |
| 0     | L      | L   | L   | L   |
| 1     | H      | L   | L   | L   |
| 2     | L      | H   | L   | L   |
| 3     | H      | H   | L   | L   |
| 4     | L      | L   | H   | L   |
| 5     | H      | L   | H   | L   |
| 6     | L      | H   | H   | L   |
| 7     | H      | H   | H   | L   |
| 8     | L      | L   | L   | H   |
| 9     | H      | L   | L   | H   |
| 10    | L      | H   | L   | H   |
| 11    | H      | H   | L   | H   |
| 12    | L      | L   | H   | H   |
| 13    | H      | L   | H   | H   |
| 14    | L      | H   | H   | H   |
| 15    | H      | H   | H   | H   |

[1] H = HIGH voltage level; L = LOW voltage level.

## 7. Limiting values

**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol    | Parameter               | Conditions                                             | Min  | Max      | Unit |
|-----------|-------------------------|--------------------------------------------------------|------|----------|------|
| $V_{CC}$  | supply voltage          |                                                        | -0.5 | +4.6     | V    |
| $I_{IK}$  | input clamping current  | $V_I < -0.5\text{ V}$ or $V_I > V_{CC} + 0.5\text{ V}$ | -    | $\pm 20$ | mA   |
| $I_{OK}$  | output clamping current | $V_O < -0.5\text{ V}$ or $V_O > V_{CC} + 0.5\text{ V}$ | -    | $\pm 50$ | mA   |
| $I_O$     | output current          | $V_O = -0.5\text{ V}$ to $V_{CC} + 0.5\text{ V}$       | -    | $\pm 25$ | mA   |
| $I_{CC}$  | supply current          |                                                        | -    | +50      | mA   |
| $I_{GND}$ | ground current          |                                                        | 50   | -        | mA   |
| $T_{stg}$ | storage temperature     |                                                        | -65  | +150     | °C   |
| $P_{tot}$ | total power dissipation | DIP14 package [1]                                      | -    | 750      | mW   |
|           |                         | SO14 package [3]                                       | -    | 500      | mW   |
|           |                         | SSOP14 and TSSOP14 packages [3]                        | -    | 400      | mW   |

[1] For DIP14 package:  $P_{tot}$  derates linearly with 12 mW/K above 70 °C.

[2] For SO14 package:  $P_{tot}$  derates linearly with 8 mW/K above 70 °C.

[3] For (T)SSOP14 packages:  $P_{tot}$  derates linearly with 5.5 mW/K above 60 °C.

## 8. Recommended operating conditions

**Table 5. Recommended operating conditions**

Voltages are referenced to GND (ground = 0 V)

| Symbol              | Parameter                           | Conditions                                | Min | Typ | Max      | Unit |
|---------------------|-------------------------------------|-------------------------------------------|-----|-----|----------|------|
| $V_{CC}$            | supply voltage                      |                                           | 1.0 | 3.3 | 3.6      | V    |
| $V_I$               | input voltage                       |                                           | 0   | -   | $V_{CC}$ | V    |
| $V_O$               | output voltage                      |                                           | 0   | -   | $V_{CC}$ | V    |
| $T_{amb}$           | ambient temperature                 |                                           | -40 | -   | +125     | °C   |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 1.0\text{ V}$ to $2.0\text{ V}$ | -   | -   | 500      | ns/V |
|                     |                                     | $V_{CC} = 2.0\text{ V}$ to $2.7\text{ V}$ | -   | -   | 200      | ns/V |
|                     |                                     | $V_{CC} = 2.7\text{ V}$ to $3.6\text{ V}$ | -   | -   | 100      | ns/V |

## 9. Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter                                     | Conditions                                                                             | –40 °C to +85 °C |                    |      | –40 °C to +125 °C |      | Unit |
|------------------|-----------------------------------------------|----------------------------------------------------------------------------------------|------------------|--------------------|------|-------------------|------|------|
|                  |                                               |                                                                                        | Min              | Typ <sup>[1]</sup> | Max  | Min               | Max  |      |
| V <sub>IH</sub>  | HIGH-level input voltage                      | V <sub>CC</sub> = 1.2 V                                                                | 0.9              | -                  | -    | 0.9               | -    | V    |
|                  |                                               | V <sub>CC</sub> = 2.0 V                                                                | 1.4              | -                  | -    | 1.4               | -    | V    |
|                  |                                               | V <sub>CC</sub> = 2.7 V to 3.6 V                                                       | 2.0              | -                  | -    | 2.0               | -    | V    |
| V <sub>IL</sub>  | LOW-level input voltage                       | V <sub>CC</sub> = 1.2 V                                                                | -                | -                  | 0.3  | -                 | 0.3  | V    |
|                  |                                               | V <sub>CC</sub> = 2.0 V                                                                | -                | -                  | 0.6  | -                 | 0.6  | V    |
|                  |                                               | V <sub>CC</sub> = 2.7 V to 3.6 V                                                       | -                | -                  | 0.8  | -                 | 0.8  | V    |
| V <sub>OH</sub>  | HIGH-level output voltage                     | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                    |                  |                    |      |                   |      |      |
|                  |                                               | I <sub>O</sub> = –100 µA; V <sub>CC</sub> = 1.2 V                                      | -                | 1.2                | -    | -                 | -    | V    |
|                  |                                               | I <sub>O</sub> = –100 µA; V <sub>CC</sub> = 2.0 V                                      | 1.8              | 2.0                | -    | 1.8               | -    | V    |
|                  |                                               | I <sub>O</sub> = –100 µA; V <sub>CC</sub> = 2.7 V                                      | 2.5              | 2.7                | -    | 2.5               | -    | V    |
|                  |                                               | I <sub>O</sub> = –100 µA; V <sub>CC</sub> = 3.0 V                                      | 2.80             | 3.0                | -    | 2.8               | -    | V    |
|                  |                                               | I <sub>O</sub> = –6 mA; V <sub>CC</sub> = 3.0 V                                        | 2.40             | 2.82               | -    | 2.20              | -    | V    |
| V <sub>OL</sub>  | LOW-level output voltage                      | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                    |                  |                    |      |                   |      |      |
|                  |                                               | I <sub>O</sub> = 100 µA; V <sub>CC</sub> = 1.2 V                                       | -                | 0                  | -    | -                 | -    | V    |
|                  |                                               | I <sub>O</sub> = 100 µA; V <sub>CC</sub> = 2.0 V                                       | -                | 0                  | 0.2  | -                 | 0.2  | V    |
|                  |                                               | I <sub>O</sub> = 100 µA; V <sub>CC</sub> = 2.7 V                                       | -                | 0                  | 0.2  | -                 | 0.2  | V    |
|                  |                                               | I <sub>O</sub> = 100 µA; V <sub>CC</sub> = 3.0 V                                       | -                | 0                  | 0.2  | -                 | 0.2  | V    |
|                  |                                               | I <sub>O</sub> = 6 mA; V <sub>CC</sub> = 3.0 V                                         | -                | 0.25               | 0.40 | -                 | 0.50 | V    |
| I <sub>I</sub>   | input leakage current                         | V <sub>I</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 3.6 V                       | -                | -                  | 1.0  | -                 | 1.0  | µA   |
| I <sub>CC</sub>  | supply current                                | V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 3.6 V | -                | -                  | 20.0 | -                 | 160  | µA   |
| ΔI <sub>CC</sub> | additional quiescent supply current per input | V <sub>I</sub> = V <sub>CC</sub> – 0.6 V; V <sub>CC</sub> = 2.7 V to 3.6 V             | -                | -                  | 500  | -                 | 850  | µA   |
| C <sub>I</sub>   | input capacitance                             |                                                                                        | -                | 3.5                | -    | -                 | -    | pF   |

[1] All typical values are measured at T<sub>amb</sub> = 25 °C.

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V);  $C_L = 50$  pF unless otherwise specified; for test circuit, see [Figure 10](#).

| Symbol    | Parameter                     | Conditions                                                              | –40 °C to +85 °C |                    |     | –40 °C to +125 °C |     | Unit |
|-----------|-------------------------------|-------------------------------------------------------------------------|------------------|--------------------|-----|-------------------|-----|------|
|           |                               |                                                                         | Min              | Typ <sup>[1]</sup> | Max | Min               | Max |      |
| $t_{pd}$  | propagation delay             | $\overline{nCP}$ to $nQ0$ ; see <a href="#">Figure 8</a> <sup>[3]</sup> |                  |                    |     |                   |     |      |
|           |                               | $V_{CC} = 1.2$ V                                                        | -                | 75                 | -   | -                 | -   | ns   |
|           |                               | $V_{CC} = 2.0$ V                                                        | -                | 26                 | 49  | -                 | 60  | ns   |
|           |                               | $V_{CC} = 2.7$ V                                                        | -                | 19                 | 36  | -                 | 44  | ns   |
|           |                               | $V_{CC} = 3.3$ V, $C_L = 15$ pF                                         | -                | 12                 | -   | -                 | -   | ns   |
|           |                               | $V_{CC} = 3.0$ V to 3.6 V                                               | -                | 14                 | 29  | -                 | 35  | ns   |
|           |                               | $nQ$ to $nQn+1$ ; see <a href="#">Figure 8</a> <sup>[3]</sup>           |                  |                    |     |                   |     |      |
|           |                               | $V_{CC} = 1.2$ V                                                        | -                | 25                 | -   | -                 | -   | ns   |
|           |                               | $V_{CC} = 2.0$ V                                                        | -                | 9                  | 17  | -                 | 20  | ns   |
|           |                               | $V_{CC} = 2.7$ V                                                        | -                | 6                  | 13  | -                 | 15  | ns   |
|           |                               | $V_{CC} = 3.3$ V, $C_L = 15$ pF                                         | -                | 4                  | -   | -                 | -   | ns   |
|           |                               | $V_{CC} = 3.0$ V to 3.6 V                                               | -                | 5 <sup>[2]</sup>   | 10  | -                 | 12  | ns   |
| $t_{PHL}$ | HIGH to LOW propagation delay | $nMR$ to $nQx$ ; see <a href="#">Figure 9</a>                           |                  |                    |     |                   |     |      |
|           |                               | $V_{CC} = 1.2$ V                                                        | -                | 70                 | -   | -                 | -   | ns   |
|           |                               | $V_{CC} = 2.0$ V                                                        | -                | 24                 | 44  | -                 | 54  | ns   |
|           |                               | $V_{CC} = 2.7$ V                                                        | -                | 18                 | 33  | -                 | 40  | ns   |
|           |                               | $V_{CC} = 3.3$ V, $C_L = 15$ pF                                         | -                | 11                 | -   | -                 | -   | ns   |
|           |                               | $V_{CC} = 3.0$ V to 3.6 V                                               | -                | 13 <sup>[2]</sup>  | 26  | -                 | 32  | ns   |
| $t_t$     | transition time               | $nQx$ ; see <a href="#">Figure 8</a> <sup>[4]</sup>                     |                  |                    |     |                   |     |      |
|           |                               | $V_{CC} = 2.0$ V                                                        | -                | -                  | -   | -                 | -   | ns   |
|           |                               | $V_{CC} = 2.7$ V                                                        | -                | -                  | -   | -                 | -   | ns   |
|           |                               | $V_{CC} = 3.0$ V to 3.6 V                                               | -                | -                  | -   | -                 | -   | ns   |
| $t_w$     | pulse width                   | $\overline{nCP}$ HIGH or LOW; see <a href="#">Figure 8</a>              |                  |                    |     |                   |     |      |
|           |                               | $V_{CC} = 2.0$ V                                                        | 34               | 10                 | -   | 41                | -   | ns   |
|           |                               | $V_{CC} = 2.7$ V                                                        | 25               | 8                  | -   | 30                | -   | ns   |
|           |                               | $V_{CC} = 3.0$ V to 3.6 V                                               | 20               | 6 <sup>[2]</sup>   | -   | 24                | -   | ns   |
|           |                               | $nMR$ HIGH; see <a href="#">Figure 9</a>                                |                  |                    |     |                   |     |      |
|           |                               | $V_{CC} = 2.0$ V                                                        | 34               | 12                 | -   | 41                | -   | ns   |
|           |                               | $V_{CC} = 2.7$ V                                                        | 25               | 9                  | -   | 30                | -   | ns   |
|           |                               | $V_{CC} = 3.0$ V to 3.6 V                                               | 20               | 7 <sup>[2]</sup>   | -   | 24                | -   | ns   |
| $t_{rec}$ | recovery time                 | $nMR$ to $\overline{nCP}$ ; see <a href="#">Figure 9</a>                |                  |                    |     |                   |     |      |
|           |                               | $V_{CC} = 1.2$ V                                                        | -                | 5                  | -   | -                 | -   | ns   |
|           |                               | $V_{CC} = 2.0$ V                                                        | 5                | 2                  | -   | 5                 | -   | ns   |
|           |                               | $V_{CC} = 2.7$ V                                                        | 5                | 2                  | -   | 5                 | -   | ns   |
|           |                               | $V_{CC} = 3.0$ V to 3.6 V                                               | 5                | 1 <sup>[2]</sup>   | -   | 5                 | -   | ns   |

**Table 7. Dynamic characteristics ...continued**

Voltages are referenced to GND (ground = 0 V);  $C_L = 50$  pF unless otherwise specified; for test circuit, see [Figure 10](#).

| Symbol     | Parameter                     | Conditions                                   | –40 °C to +85 °C |                    |     | –40 °C to +125 °C |     | Unit |
|------------|-------------------------------|----------------------------------------------|------------------|--------------------|-----|-------------------|-----|------|
|            |                               |                                              | Min              | Typ <sup>[1]</sup> | Max | Min               | Max |      |
| $f_{\max}$ | maximum frequency             | see <a href="#">Figure 8</a>                 |                  |                    |     |                   |     |      |
|            |                               | $V_{CC} = 2.0$ V                             | 14               | 53                 | -   | 12                | -   | MHz  |
|            |                               | $V_{CC} = 2.7$ V                             | 19               | 72                 | -   | 16                | -   | MHz  |
|            |                               | $V_{CC} = 3.3$ V, $C_L = 15$ pF              | -                | 99                 | -   | -                 | -   | MHz  |
|            |                               | $V_{CC} = 3.0$ V to $3.6$ V                  | 24               | 90 <sup>[2]</sup>  | -   | 20                | -   | MHz  |
| $C_{PD}$   | power dissipation capacitance | $V_I = \text{GND to } V_{CC}$ <sup>[5]</sup> | -                | 23 <sup>[2]</sup>  | -   | -                 | -   | pF   |

[1] All typical values are measured at  $T_{\text{amb}} = 25$  °C.

[2] Typical values are measured at  $V_{CC} = 3.3$  V.

[3]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[4]  $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .

[5]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where:

$f_i$  = input frequency in MHz;

$f_o$  = output frequency in MHz;

$C_L$  = output load capacitance in pF;

$V_{CC}$  = supply voltage in V;

$N$  = number of inputs switching;

$\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

10.1 Waveforms

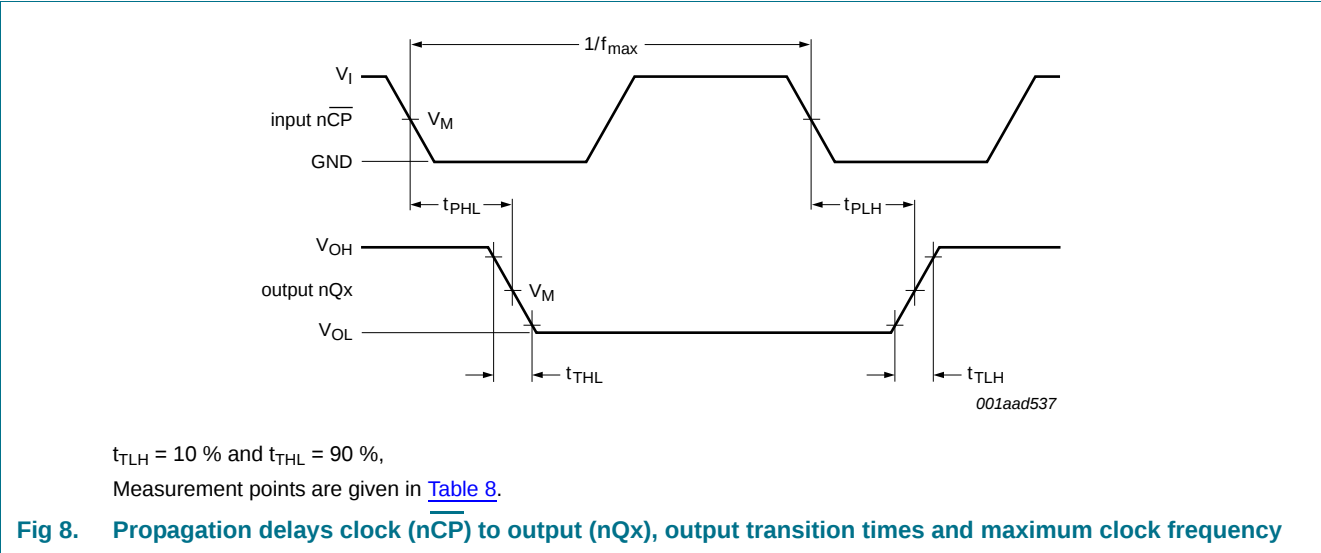
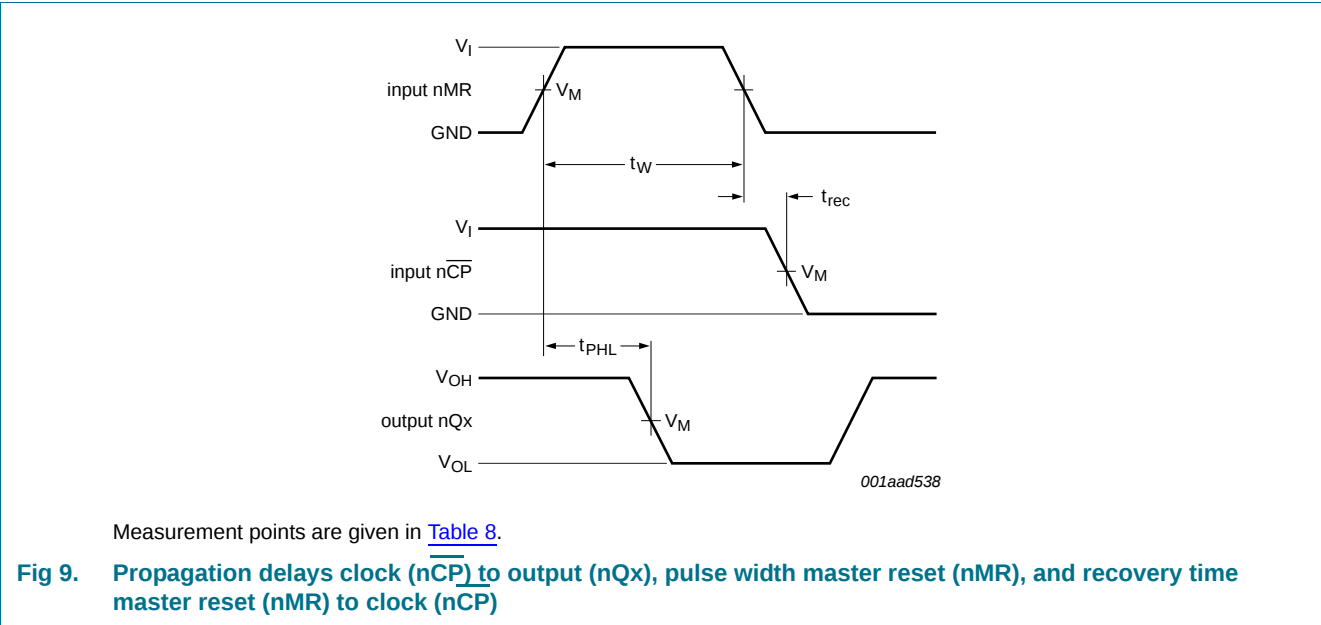
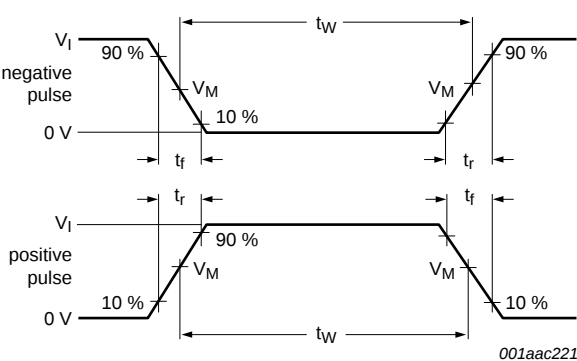


Table 8. Measurement points

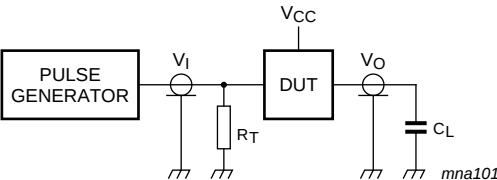
| Supply voltage $V_{CC}$ | Input       | Output      |                      |                      |
|-------------------------|-------------|-------------|----------------------|----------------------|
|                         | $V_M$       | $V_M$       | $V_X$                | $V_Y$                |
| < 2.7 V                 | $0.5V_{CC}$ | $0.5V_{CC}$ | $V_{OL} + 0.1V_{CC}$ | $V_{OH} - 0.1V_{CC}$ |
| 2.7 V to 3.6 V          | $1.5V_{CC}$ | $1.5V_{CC}$ | $V_{OL} + 0.3V_{CC}$ | $V_{OH} - 0.3V_{CC}$ |





Measurement points are given in [Table 8](#).

a. Input pulse definition



Test data is given in [Table 9](#).

Definitions test circuit:

$R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

$C_L$  = Load capacitance including jig and probe capacitance.

b. Test circuit

Fig 10. Test circuit for measuring switching times

Table 9. Test data

| Supply voltage $V_{CC}$ | Input    |              | Load         |              | Test               |
|-------------------------|----------|--------------|--------------|--------------|--------------------|
|                         | $V_I$    | $t_r, t_f$   | $C_L$        | $R_L$        |                    |
| 1.2 V                   | $V_{CC}$ | $\leq 25$ ns | 50 pF        | 1 k $\Omega$ | $t_{PHL}, t_{PLH}$ |
| 2.0 V                   | $V_{CC}$ | $\leq 25$ ns | 50 pF        | 1 k $\Omega$ | $t_{PHL}, t_{PLH}$ |
| 2.7 V                   | 2.7 V    | $\leq 25$ ns | 50 pF        | 1 k $\Omega$ | $t_{PHL}, t_{PLH}$ |
| 3.0 V to 3.6 V          | 2.7 V    | $\leq 25$ ns | 50 pF, 15 pF | 1 k $\Omega$ | $t_{PHL}, t_{PLH}$ |

11. Package outline

DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1

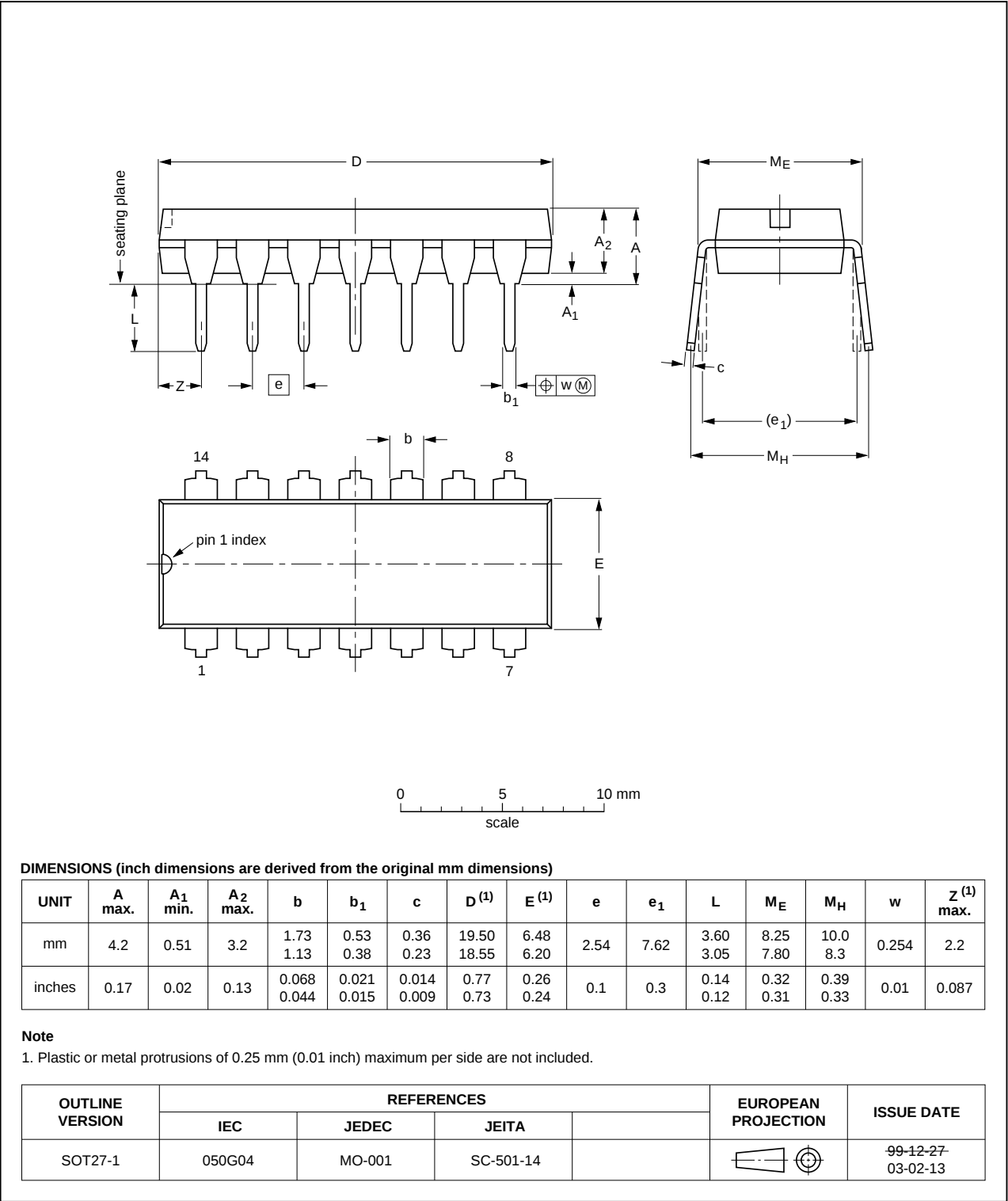


Fig 11. Package outline SOT27-1 (DIP14)

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1

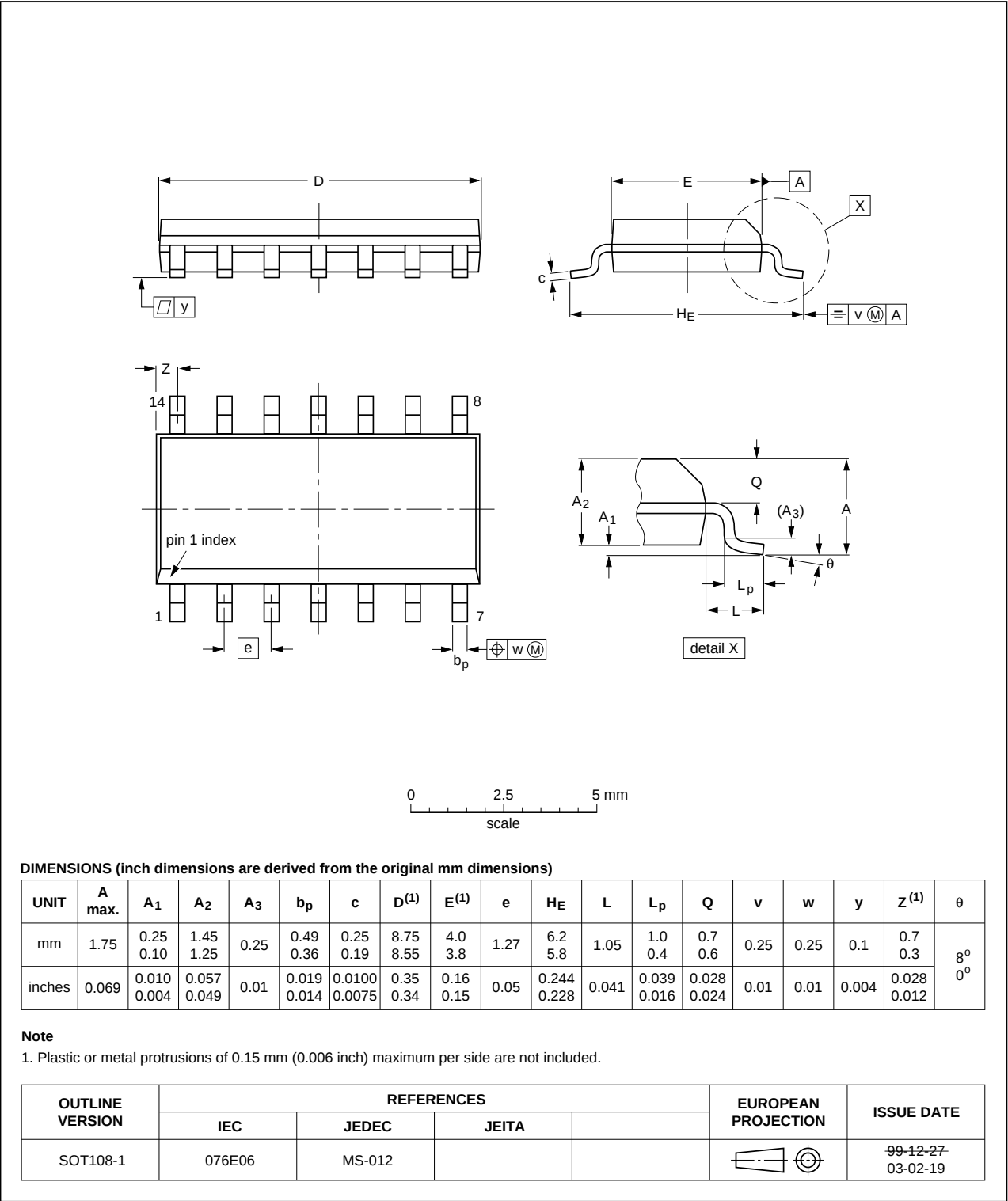


Fig 12. Package outline SOT108-1 (SO14)

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1

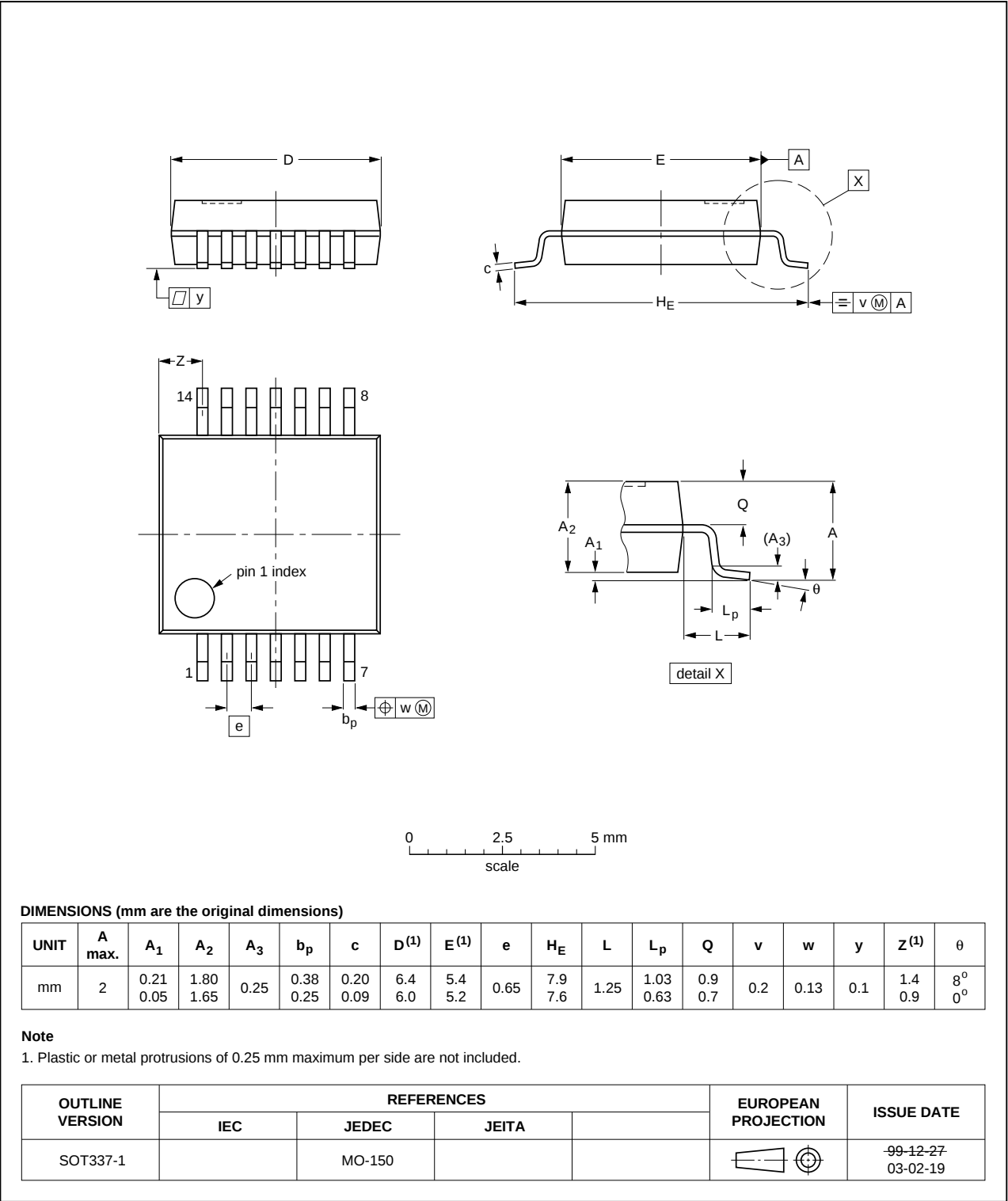


Fig 13. Package outline SOT337-1 (SSOP14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1

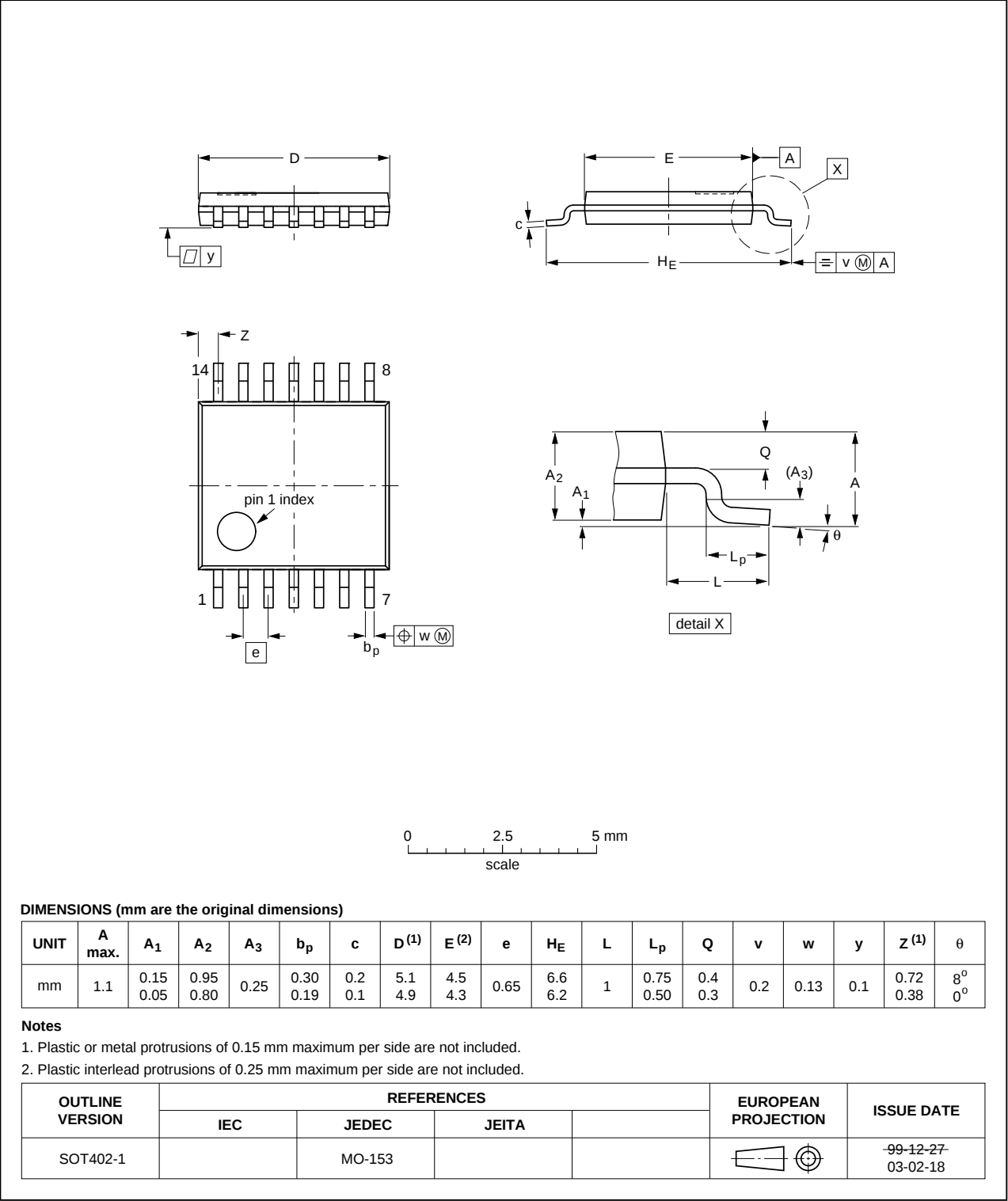


Fig 14. Package outline SOT402-1 (TSSOP14)

## 12. Abbreviations

Table 10. Abbreviations

| Acronym | Description             |
|---------|-------------------------|
| CDM     | Charged Device Model    |
| DUT     | Device Under Test       |
| ESD     | ElectroStatic Discharge |
| HBM     | Human Body Model        |
| MIL     | Military                |
| MM      | Machine Model           |

## 13. Revision history

Table 11. Revision history

| Document ID    | Release date                                                                                                                                                                                                                                         | Data sheet status     | Change notice | Supersedes  |
|----------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|---------------|-------------|
| 74LV393 v.3    | 20140428                                                                                                                                                                                                                                             | Product data sheet    | -             | 74LV393 v.2 |
| Modifications: | <ul style="list-style-type: none"><li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li><li>Legal texts have been adapted to the new company name where appropriate.</li></ul> |                       |               |             |
| 74LV393 v.2    | 19970610                                                                                                                                                                                                                                             | Product specification | -             | 74LV393 v.1 |
| 74LV393 v.1    | 19970304                                                                                                                                                                                                                                             | Product specification | -             | -           |

## 14. Legal information

### 14.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition                                                                            |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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